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P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY							
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^{a, e}	Q _g (Typ.)				
- 30	0.042 at V _{GS} = - 10 V	- 6	7 nC				
- 30	0.072 at V _{GS} = - 4.5 V	- 6	7110				

FEATURES

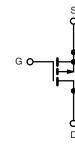
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



FREE

APPLICATIONS

- Load Switch
- · Notebook Adaptor Switch



P-Channel MOSFET

		SO-8		
S	1		8	D
S	2		7	D
S	3		6	D
G	4		5	D
	l	Top View	J	

Ordering Information: Si4485DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATIN	$IGS T_A = 25 °C,$	1		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	- 30	V
Gate-Source Voltage		V_{GS}	± 20	v
	T _C = 25 °C		- 6 ^e	
Continuous Prain Current (T = 150 °C)	T _C = 70 °C	I _D	- 6 ^e	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C		- 5.9 ^{b, c}	
	T _A = 70 °C		- 4.7 ^{b, c}	Α
Pulsed Drain Current		I _{DM}	- 25	
Continous Source-Drain Diode Current	T _C = 25 °C	I.	- 4.2	
Continues Source-Drain Diode Current	T _A = 25 °C	I _S	- 2 ^{b, c}	
	T _C = 25 °C		5	
Maximum Power Dissipation	T _C = 70 °C	1 5	3.2	w
	T _A = 25 °C	- P _D	2.4 ^{b, c}	VV
	T _A = 70 °C	1	1.5 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	42	53	°C/W		
Maximum Junction-to-Foot (Drain) Steady State		R_{thJF}	19	25	O/ VV		

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.
- e. Package Limited.

Si4485DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 19		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 _D = - 250 μΑ		4.4		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = -250 \mu A$	- 1.2		- 2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	1	V _{DS} = - 30 V, V _{GS} = 0 V			- 1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 55 °C			- 5	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 25			Α
Durin Orange On Olate Besidence	В	V _{GS} = - 10 V, I _D = - 5.9 A		0.035	0.042	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 4.5 A		0.060	0.072	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 5.9 A		10		S
Dynamic ^b						
Input Capacitance	C _{iss}			590		
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		115		pF
Reverse Transfer Capacitance	C _{rss}	1		93		
Tatal Cata Chausa	Qg	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 5.9 A		13.6	21	nC
Total Gate Charge				7	11	
Gate-Source Charge	Q_{gs}	V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 5.9 A		2.3		
Gate-Drain Charge	Q_{gd}			3.2		
Gate Resistance	R_g	f = 1 MHz	1	5	10	Ω
Turn-On Delay Time	t _{d(on)}			30	45	
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 3.2 \Omega$		25	38	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 4.7 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		16	24	
Fall Time	t _f			8	16	
Turn-On Delay Time	t _{d(on)}			8	16	ns
Rise Time	t _r	$V_{DD} = -15 \text{ V}, R_{L} = 3.2 \Omega$		10	20	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 4.7 A, V_{GEN} = - 10 V, R_g = 1 Ω		18	27	
Fall Time	t _f	1		8	16	
Drain-Source Body Diode Characteristic	cs			•	'	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 4.2	Δ
Pulse Diode Forward Current	I _{SM}				- 25	A
Body Diode Voltage	V_{SD}	I _S = - 4.7 A, V _{GS} = 0 V		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			17	26	ns
Body Diode Reverse Recovery Charge	Q _{rr}			9	18	nC
Reverse Recovery Fall Time	t _a	I _F = - 4.7 A, dl/dt = 100 A/μs, T _J = 25 °C		10		ns
Reverse Recovery Rise Time	t _b			7		

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

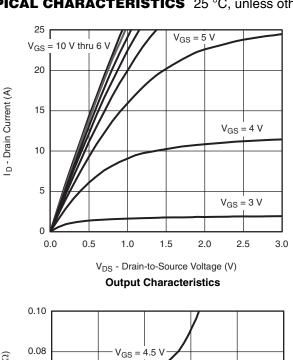
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

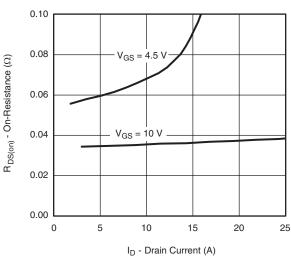
b. Guaranteed by design, not subject to production testing.

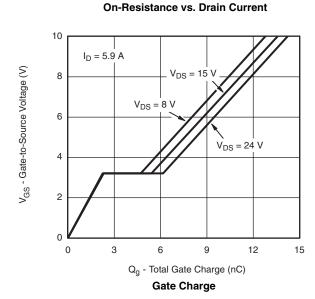


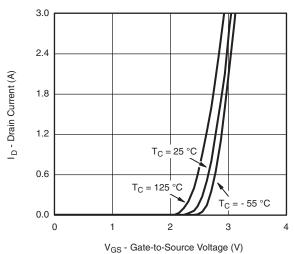


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

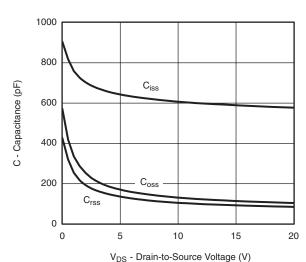




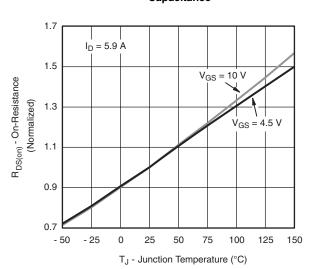








Capacitance

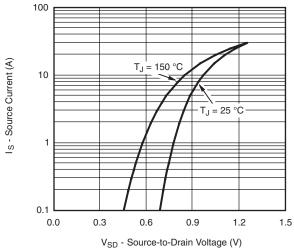


On-Resistance vs. Junction Temperature

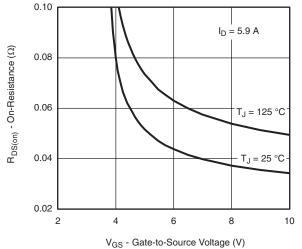
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

30

25

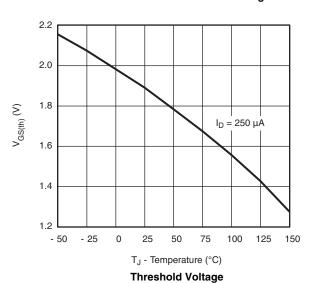
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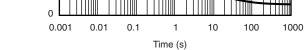
15

10

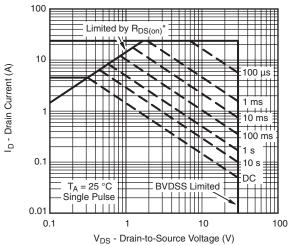
5

Power (W)





Single Pulse Power (Junction-to-Ambient)

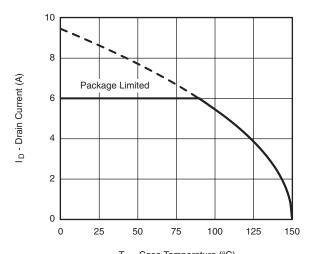


* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area, Junction-to-Ambient

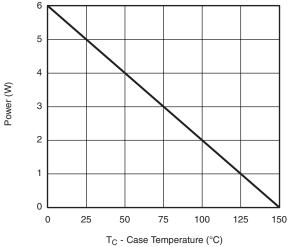


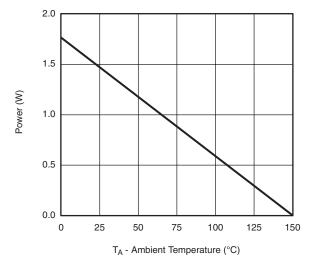
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T_C - Case Temperature (°C)

Current Derating*





Power, Junction-to-Foot

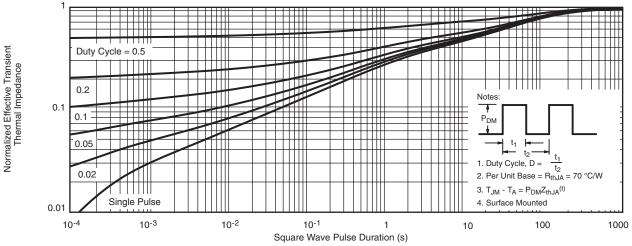
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

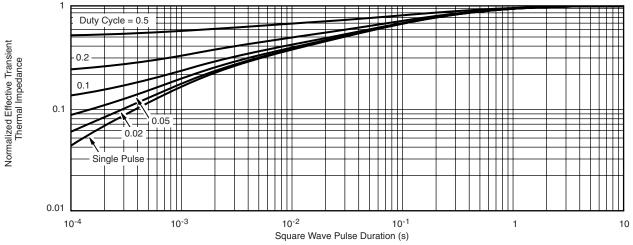
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

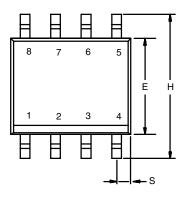


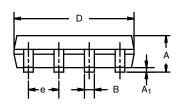
Normalized Thermal Transient Impedance, Junction-to-Foot

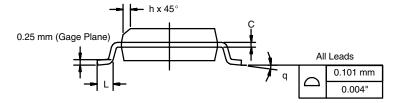
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

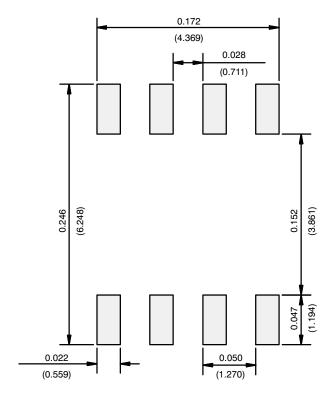
DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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